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To the Honorable Commissioner of  
Please record the attached origi

102472246

1. Name of conveying party(ies):

Shinzi KAWANO  
Fumi IZUMI

2. Name and address of receiving party(ies):

Name: TEIJIN CHEMICALS, LTD.

Internal Address:

Additional name(s) of conveying party(ies)  
attached?  Yes  No

Street Address: 2-2, Uchisaiwaicho 1-chome

Chiyoda-ku

City: Tokyo State: Japan ZIP: 100-0011

3. Nature of Conveyance

Assignment  Merger

Security Agreement  Change of Name

Other \_\_\_\_\_

Execution Date: December 12, 2002

Additional name(s) & address(es) attached?  Yes  No

4. Application number(s) or patent number(s):

10333214

If this document is being filed together with a new application, the execution date  
of the application is: December 12, 2002

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address of party to whom  
correspondence concerning document  
should be mailed:

Name: SHERMAN & SHALLOWAY

Internal Address: \_\_\_\_\_

Street Address: \_\_\_\_\_

413 North Washington Street

City: Alexandria State: VA

ZIP: 22314

6. Total number of applications and patents  
involved:..... [ 1 ]

7. Total fee (37 CFR 3.41).....\$40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying  
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any  
attached copy is a true copy of the original document

Leonard W. Sherman  
Name of Person Signing

Signature

January 16, 2003  
Date

Total number of pages including cover sheet, attachments, and document [ 2 ]

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# ASSIGNMENT

WHEREAS, We, Shinzi KAWANO and Fumi IZUMI

residing at Chiyoda-ku, TOKYO, JAPAN

(hereinafter referred to as Inventors), have invented certain new and useful improvements in POLYCARBONATE RESIN MOLDING MATERIAL FOR OPTICAL USE

; for which an application for United States Letters Patent was signed by us on December 12, 2002 and filed in the United States on \_\_\_\_\_ and assigned Serial Number \_\_\_\_\_.

WHEREAS, TEIJIN CHEMICALS, LTD.

a corporation of Japan, having a place of business at 2-2, Uchisaiwaicho 1-chome, Chiyoda-ku, TOKYO 100-001 JAPAN

(hereinafter referred to as Company), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, the receipt whereof is hereby acknowledged, and other valuable considerations, the said Inventors have sold, assigned and transferred, and by the presents do sell, assign and transfer unto said Company, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent, which may be granted thereof in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Company as the assignee of the entire right, title and interest in and to the same, for the sole use and behoof of the said Company, its successors and assigns.

FURTHER, We agree that we will communicate to said Company or its representatives any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Company, make all rightful oaths and generally do everything possible to aid said Company, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, We have hereunto set our hands this 12th day of December, 2002.

Signed in the presence of:

Witness: kuniaki Akashi Signed: Shinzi Kawano

Witness: \_\_\_\_\_ Signed: Fumi Izumi

Witness: \_\_\_\_\_ Signed: \_\_\_\_\_

Witness: \_\_\_\_\_ Signed: \_\_\_\_\_

PATENT